



IUMRS-ICEM 2018

AUGUST 19(SUN.) - 24(FRI.), 2018 / DAEJEON, KOREA

Session Title	3D Device Printing I	Session Code	Mo-H1
Date and Time	2018-08-20 / 10:30 - 12:30		
Place	Room H		
Session Chair	TBA		

Mo-H1-1

10:30 - 11:00

[Invited] Highly Conductive and Durable 3D-Printed Cu Electrodes: In-Situ Compositional/Microstructural Evolution by Optical Sintering Process

Sunho Jeong
KRICT, Korea

Mo-H1-2

11:00 - 11:30

[Invited] Fully Flexible "Flexion Film Technology" and the Touch Sensor from It

Sang Ho Kim^{1,2}
¹Kongju Nat'l Univ., Korea, ²N&B, Korea

Mo-H1-3

11:30 - 12:00

[Invited] All-Inkjet-Printed Flexible Wireless Power Transfer Module with a Configuration of Hybrid Metal-Coil/NiZn-Ferrite: Rigid Materials into Flexible

Murali Bissannagari and Jihoon Kim
Kongju Nat'l Univ., Korea